

2SK2085

Silicon N Channel MOS FET

REJ03G0996-0200

(Previous: ADE-208-1343)

Rev.2.00 Sep.07,2005

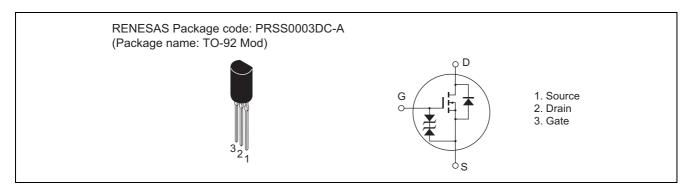
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC DC converter

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	1.0	Α
Drain peak current	I _{D(pulse)} *1	4.0	Α
Body to drain diode reverse drain current	I _{DR}	1.0	Α
Channel dissipation	Pch*2	0.9	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

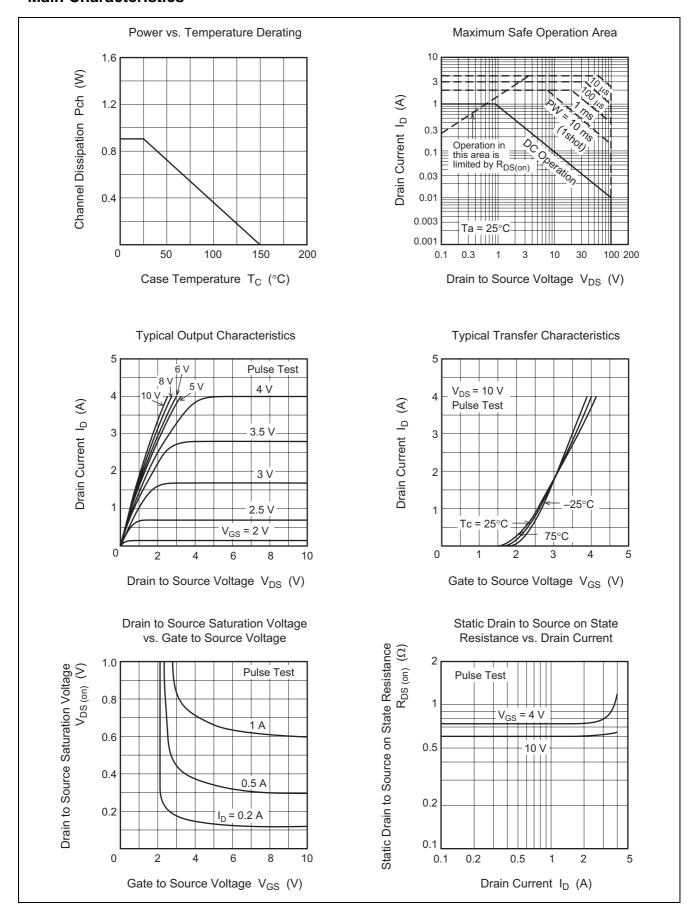
Electrical Characteristics

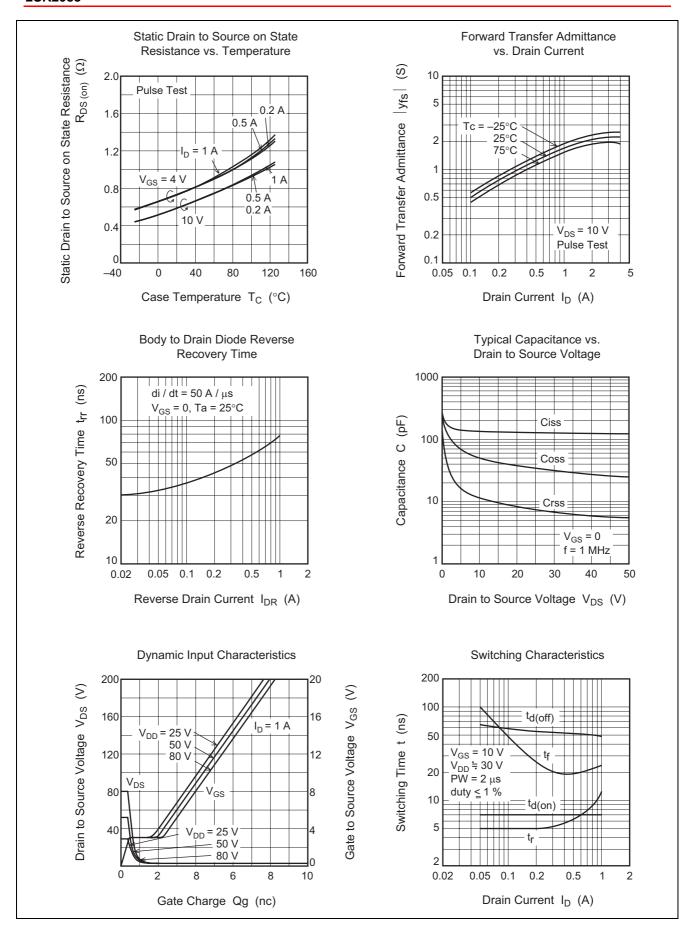
 $(Ta = 25^{\circ}C)$

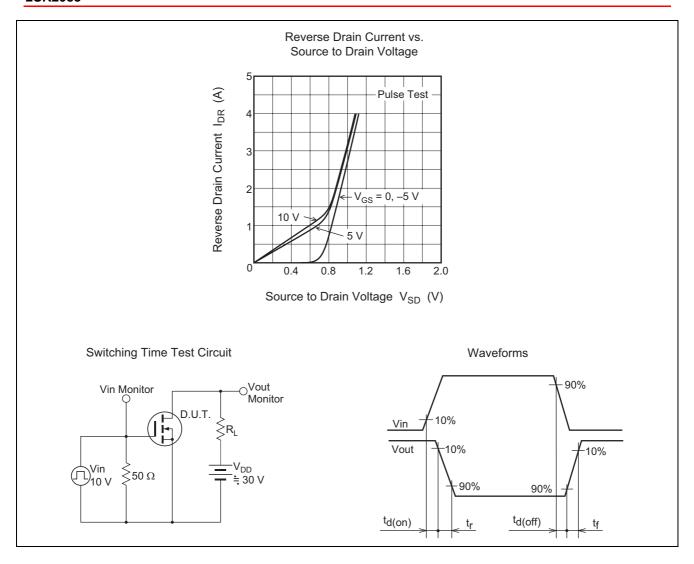
Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	$V_{(BR)DSS}$	100	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I _{DSS}		_	100	μΑ	$V_{DS} = 80 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$	
Static drain to source on state	R _{DS(on)}	_	0.6	0.9	Ω	$I_D = 0.5 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$	
resistance		_	0.75	1.35	Ω	$I_D = 0.5 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$	
Forward transfer admittance	y _{fs}	0.7	1.2	_	S	$I_D = 0.5 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$	
Input capacitance	Ciss	_	130	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	50	_	pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	12	_	pF		
Turn-on delay time	t _{d(on)}	_	7	_	ns	$I_D = 0.5 \text{ A}, V_{GS} = 10 \text{ V},$	
Rise time	t _r	_	6.5	_	ns	$R_L = 60 \Omega$	
Turn-off delay time	t _{d(off)}	_	55	_	ns		
Fall time	t _f	_	20	_	ns		
Body to drain diode forward voltage	V_{DF}	_	0.85	_	V	I _F = 1.0 A, V _{GS} = 0	
Body to drain diode reverse	t _{rr}	_	80	_	ns	$I_F = 1.0 \text{ A}, V_{GS} = 0,$	
recovery time						$di_F / dt = 50 A / \mu s$	

Note: 3. Pulse Test

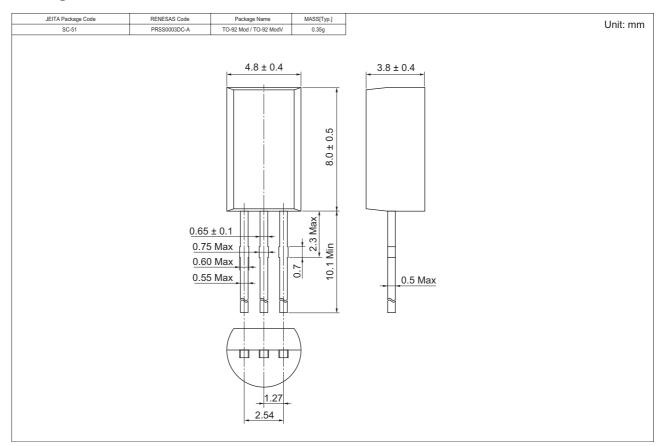
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2085TZ-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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